


Solid State Devices, Inc.

14701 Firestone Blvd * La Mirada, CA 90638

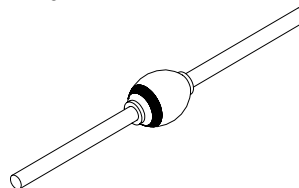
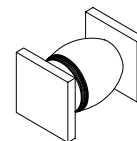
Phone: (562) 404-4474 * Fax: (562) 404-1773

 ssdi@ssdi-power.com * www.ssdi-power.com
Designer's Data Sheet
FEATURES:

- Hyper Fast Recovery: 35 nsec maximum
- PIV to 2400 Volts
- Low Reverse Leakage Current
- Hermetically Sealed
- Low Thermal Resistance
- Low trr Change at High Temperature (typical: trr = 55ns @ 100°C)
- TX, TXV, and Space Level Screening Available. Contact Factory.
- Fast Recovery Versions Available. Contact Factory.
- Single Junction Construction
- Replaces 1N6512 and 1N6513 in many applications.

**SDR2HF1.8 and SMS
SDR2HF2.0 and SMS**

2 AMPS
1800 - 2000 VOLTS
35 nsec
HYPER FAST RECOVERY
RECTIFIER

Axial

**Surface Mount
Square Tab (SMS)**


MAXIMUM RATINGS		Symbol	Value	Units
Reverse Voltage	SDR2HF1.8 & SMS SDR2HF2.0 & SMS	V_{RRM} V_{RWM} V_R	1800 2000	Volts
Average Rectified Forward Current (Resistive Load, 60 Hz, Sine Wave, $T_A=25^\circ\text{C}$, $L=.125''$)		I_O	2	Amps
Peak Surge Current (8.3 ms Pulse, Half Sine Wave, Superimposed on I_O , Allow Junction to Reach Equilibrium between Pulses, $T_A=25^\circ\text{C}$, $L=.125''$)		I_{FSM}	16	Amps
Temperature Range	Operating Storage	T_{OP} T_{stg}	-65 to +175 -65 to +200	°C
Maximum Thermal Resistance Junction to Lead, $L = 0.125''$ (Axial Lead) Junction to End Tab (Surface Mount)		$R_{\theta JL}$ $R_{\theta JE}$	6 4	°C/W

NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: RC0096B
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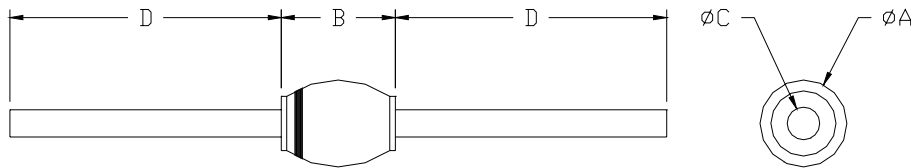
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SDR2HF1.8 and SMS SDR2HF2.0 and SMS

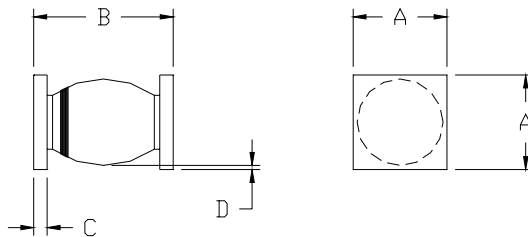
ELECTRICAL CHARACTERISTICS		Symbol	Min	Max	Unit
Breakdown Voltage ($I_R = 50 \mu A$, $T_A = 25^\circ C$, Pulse)	SDR2HF1.8 & SMS SDR2HF2.0 & SMS	BV_R	1800 2000	— —	Volts
Instantaneous Forward Voltage Drop ($T_A = 25^\circ C$, Pulse)	$I_{F1} = 1 A$	V_{F1}	—	8.0	Volts
	$I_{F2} = 2 A$	V_{F2}	—	11.0	Volts
Instantaneous Forward Voltage Drop ($T_A = -55^\circ C$, Pulse)	$I_{F3} = 1 A$	V_{F3}	—	8.0	Volts
	$I_{F4} = 2 A$	V_{F4}	—	11.0	Volts
Reverse Leakage Current ($V_R = 85\%$ rated V_R , Pulse)	$T_A = 25^\circ C$	I_{R1}	—	10	μA
	$T_A = 100^\circ C$	I_{R2}	—	250	μA
Junction Capacitance ($V_R = 50 V_{DC}$, $T_A = 25^\circ C$, $f = 1 MHz$)		C_J	—	20	pF
Reverse Recovery Time ($I_F = 500 mA$, $I_R = 1 A$, $I_{RR} = 250 mA$, $T_A = 25^\circ C$)		t_{rr}	—	35	ns

Case Outline: (Axial)



DIM	MIN	MAX
A	—	0.170"
B	0.240"	0.270"
C	0.045"	0.051"
D	1.00"	—

Case Outline: (SMS)



DIM	MIN	MAX
A	0.195"	0.205"
B	0.290"	0.330"
C	0.020"	0.030"
D	0.002"	—

NOTES:

Consult manufacturing for operating curves.

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